

WEBINAR: WE GET MICROFLUIDICS ROLLING Advantages of Roll-to-roll Replication



JANINE BROMMERT Temicon ANJA HAASE Joanneum Research

JAN KAFKA Inmold

ALVARO CONDE Micronit



13 OCTOBER 2022

www.microfluidicshub.eu

Webinar Content



INTRODUCTION Ronald Tingl – Microfluidics Innovation Hub

Part I MASTERING & TOOLING

Janine Brommert – Temicon GmbH

Part II ROLL-TO-ROLL UV IMPRINTING

Anja Haase – Materials Institute, JOANNEUM RESEARCH Mirko Lohse – micro resist technology GmbH

Part III ROLL-TO-ROLL EXTRUSION COATING Jan Kafka – Inmold A/S

Part IV BACK-END PROCESSING

Alvaro Conde – Micronit BV

SUMMARY

Ronald Tingl – Microfluidics Innovation Hub

Q & A

The NextGen Microfluidics (NGM)

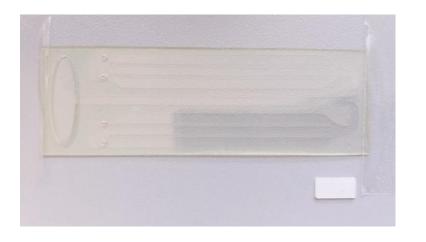
- NGM is an Open Innovation Test Bed
- Combining the competencies of 21 companies & research organizations
- The biggest platform worldwide for upscaling and testing microfluidic devices



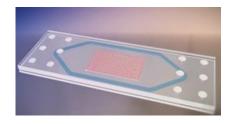


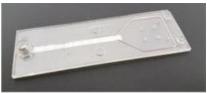
Talking Microfluidics

- We talk chips / cartridges / plates
- with microchannels, micro reaction chambers (μ l, μ m)
- performing chemical, biochemical, biological processes
- useful for medical diagnostics, chemical analysis, environmental monitoring, cell culture devices
- Lab-on-Chip, Organ-on-Chip, Soil-on-chip, Point-of-care



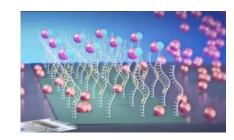






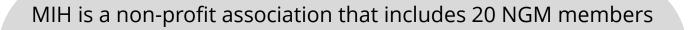


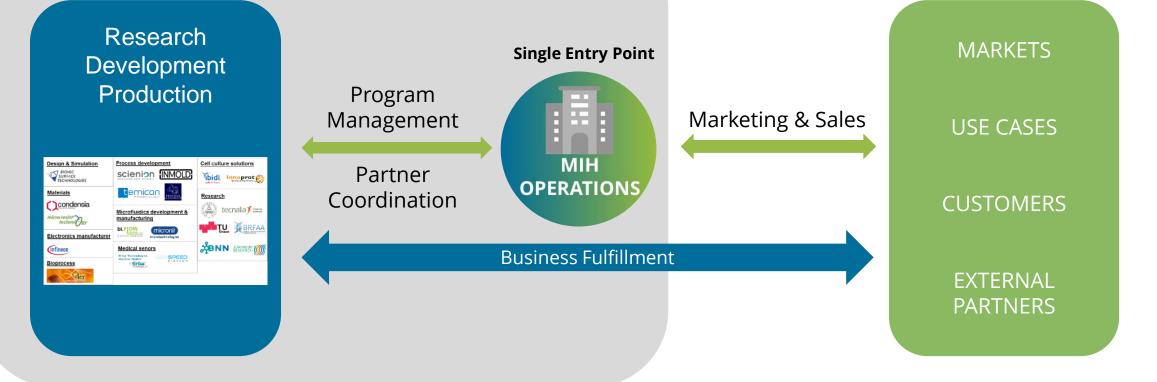






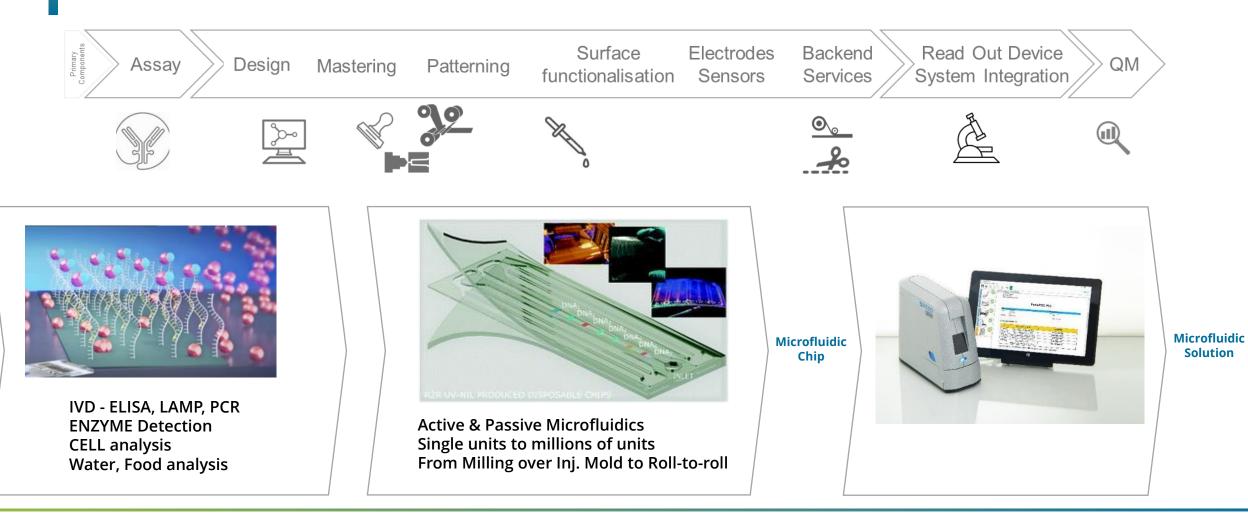
MIH – Single Entry Point to NGM Services





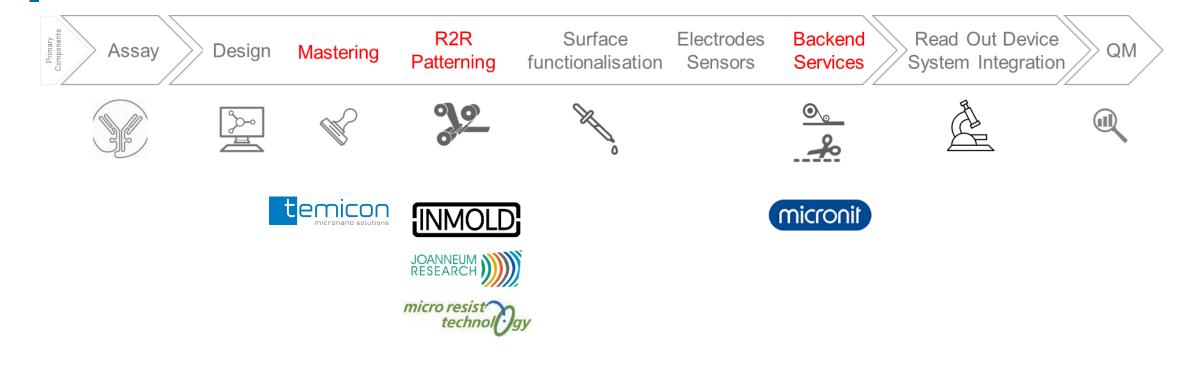


MIH Service Portfolio





Spotlight on 3 Topics





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Why Roll-to-Roll Production for Microfluidic Chips?

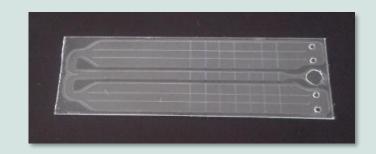
Traditional manufacturing Microfluidic Chips

Micromilling, Soft & Hot Embossing, Injection Molding



Roll-to-Roll

- High Volume / Low Cost
- Specific Microfluidic Chip Design Requirements





Overview Imprinting Technology

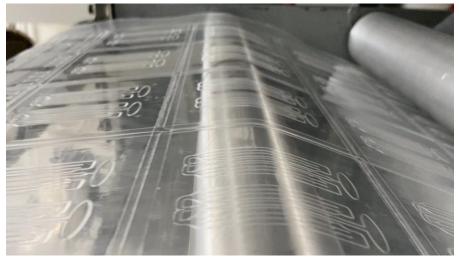
	PDMS	Micromilling	Hot Embossing	Injection Molding	R2R Replication
Throughput	Single digit	Single digit	Several 100k	Less than 1Mio	> 100k
Production costs	High	High	Medium	Low	Lowest
Flexibility	High	High	Medium	Medium	Medium
Time to prototype	Days	Days	4-6 weeks	4-6 weeks	4-6 weeks
Materials selection properties	Low	Low	High	High	Highest
Available in MIH	\checkmark	\checkmark	\checkmark	\checkmark	\checkmark



Roll-to-Roll Patterning Technologies

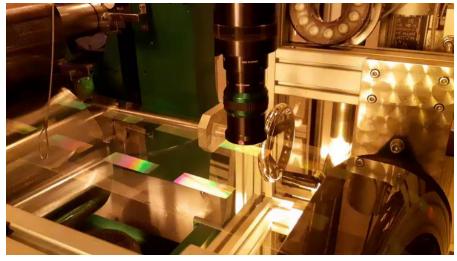


Roll to Roll Extrusion Coating



Patterning of thermoplastic foils

Roll to Roll UV-Imprinting



Patterning of UV photopolymers on substrate foils





Mastering and Tooling







temicon Company Profile



temicon is worldwide leading in series production of micro structured and nano structured components, films and functional surfaces.

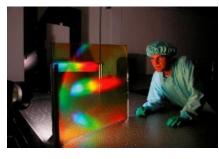
- Founded in 2005 by Oliver Humbach
- Located in Dortmund, Freiburg (Germany) and Shenzhen (China)
- 70 Employees
- Clean Room Production ISO 5
- Worldwide Markets in Lighting, Display, Solar, Optics and Life Science





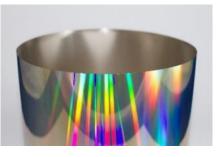
temicon Company Profile

Lithography



- Laser Interference Lithography (250 nm upwards), up to 1 m²
- UV Lithography (2 µm upwards), up to 20"x 24"

Electroforming



- 4" 20"x 24"
- 50 µm 3 mm thickness
- Soft Ni (250 Hv), Intermediate Ni (450Hv) & Hard Ni (650 Hv)

Injection Molding



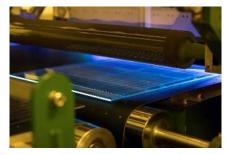
- Flexible Prototyping Tool
- PMMA, PC, COC/COP, PP, ABS
- Automated part removal

R2R Imprint



- Im production width
- Up to 60 m/min production speed
- Film thickness 20 μm 250 μm
- Inline Quality Control

R2P Imprint



- PMMA, PC and Glass substrates
- Up to 1,1 x 1,6 m substrates



UV Lithography Mastering



Spincoating of the resin

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The given design is transfered into a lithography mask. This structure is optically imprinted via UV irradiation into a photoresist. After development of the resist the non cured areas can be removed and only the cured parts of the structure remain. The created cavities can filled up with Ni during the electroforming process.



Electroforming

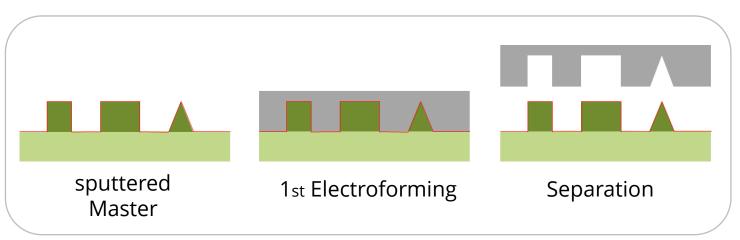


Sputtered Master

The master is sputtered to become conductive contacted and processed within an electroforming plant. Nickel growth on top the given masterstructures.

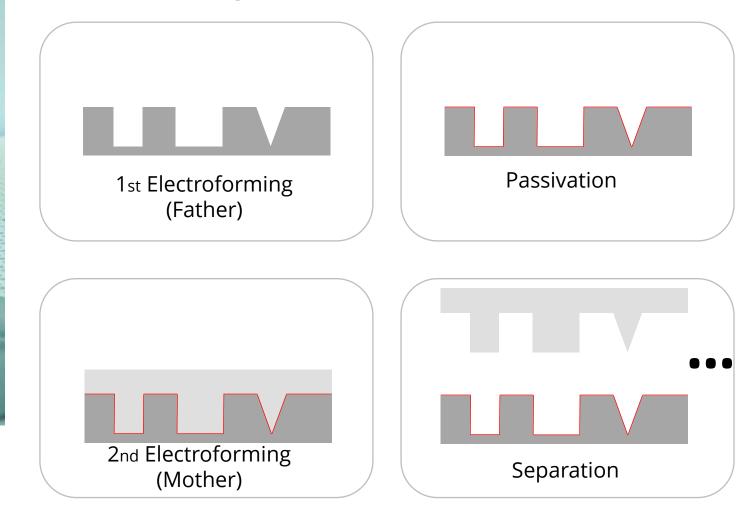
This 1st Ni-Shim is called the "Father". The master is usually destroyed during the separation from the father, but the father can be used directly or is origin of many copys.

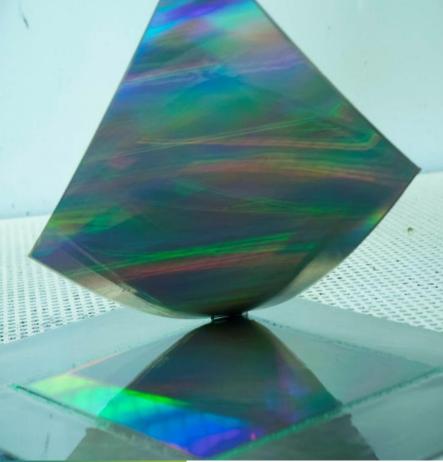
Male members of a family have the inverted structure of the master, females the original one.



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Electroforming -Family Process

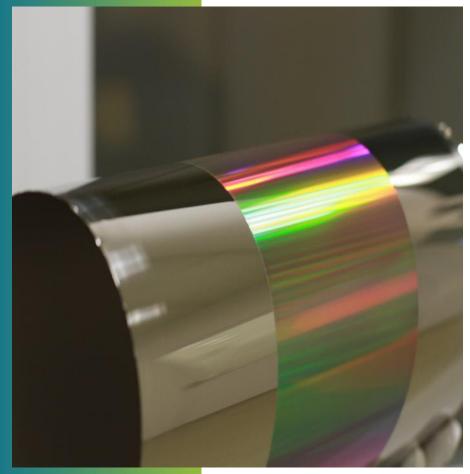




Separation

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Tooling – Sleeves



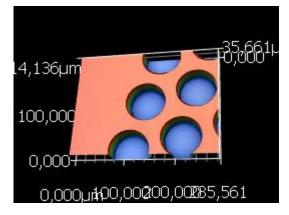
The intermediate product resulting from the electroforming is a flat shim. To come to a R2R tool it is necessary to transfer it into a cylindric form. Therefore the shim is bend and welded at the two connecting edges.

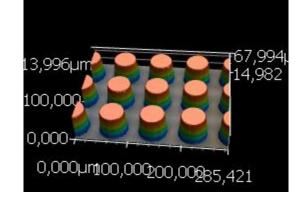
To grant a sufficient flexibility of the shim the thickness is usually between 150 -200 μ m. By connecting several shims, a tool area of more than $1m^2$ can be realized while the seam lines can be reduced down to 30 μ m width and 10 μ m height.

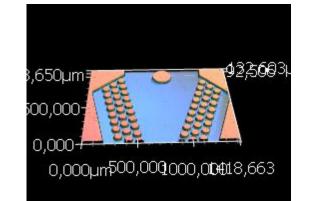
Sleeve

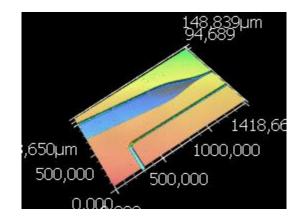


Typical structure examples









General Data

- Feature sizes 250 nm-200 μm
- 2-layer structures possible
- Draft angle 85° ± 3°
- Aspect ratio up to 3
- Different coatings for shims and sleeves available

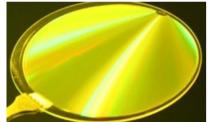


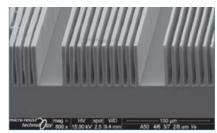


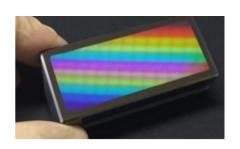


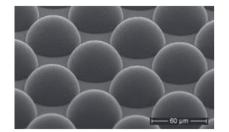


micro resist technology GmbH

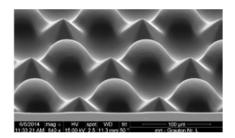


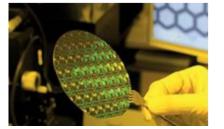


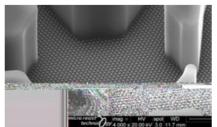














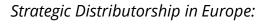
micro resist technology

Specialized in providing **innovative resists**, **polymers**, and **photopolymers**. We support our high-tech costumers as a single-entry point to high performance materials, technologies and process solutions

- Established: 1993 (Berlin, Germany)
- Employees: 50+ (2022)
- Facility: 3.450 m² incl. clean room (300 m²)
 - Certifications: ISO 9001:2015 ISO 14001:2015

Fields of business activities:

- Manufacturing: formulation / synthesis
- Researching advanced materials and processes
- Lithographic Services

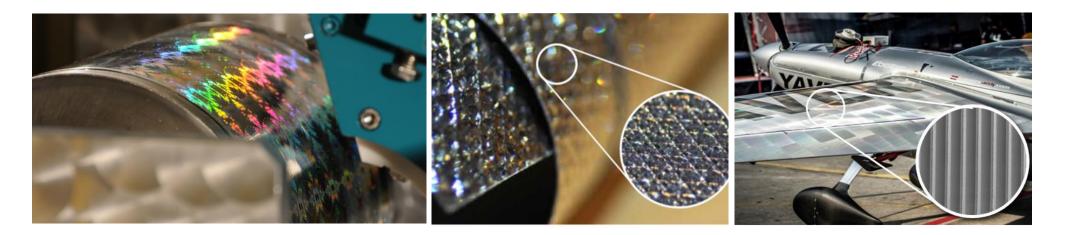


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The Materials Institute JOANNEUM RESEARCH Forschungsgesellschaft mbH



Austrian research company

500 Employees 7 Research units 20 People in Microfluidics area

R2R-UV imprinting Pilot line

- Material (NIL Cure[®])
- Design (Simulation)
- Mastering & Tooling (Step & Repeat)
- Pilot line production

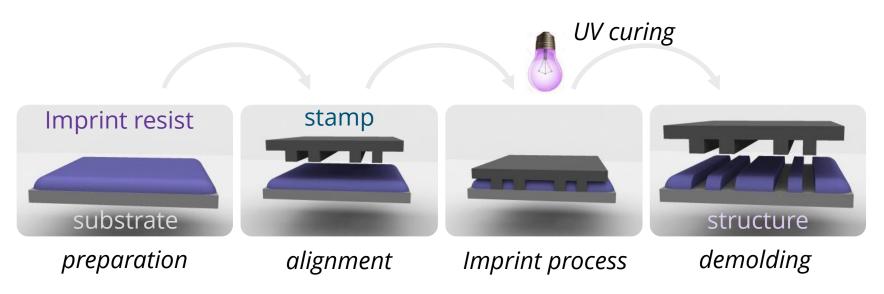


Various Applications

- ✓ Bionic Surfaces
- ✓ Decorative Films
- ✓ Microfluidic Films
- ✓ (freeform) Micro-optic Films

Micro and Nano - UV Imprinting

- Very simple method for replication of micro- and nanostructures
- Curing process either with UV light or temperature
- Very flexible with respect to geometries, sizes, and forms
- Lateral resolution independent on optical wavelength





Microstructured cured resin layer on film substrate **UV lamp** tamp Liquid UVcurable resin

Key features

- Aspect ratio (H/W): 2:1
- Web speed: 0.5-30 m/min

Substrates

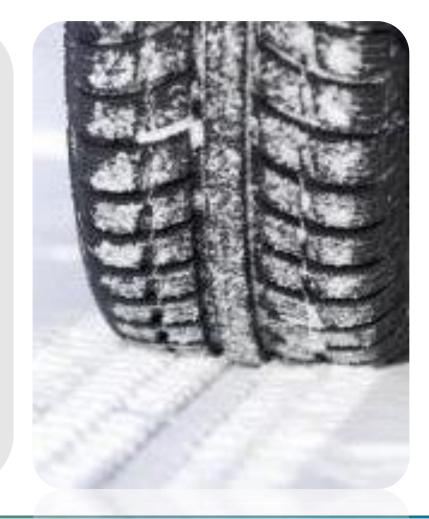
- Polymer, PET, PEN,COC, etc.
- Transparent
- Thickness: 20 μm to 250 μm

Resin

UV-curable resin

Structures

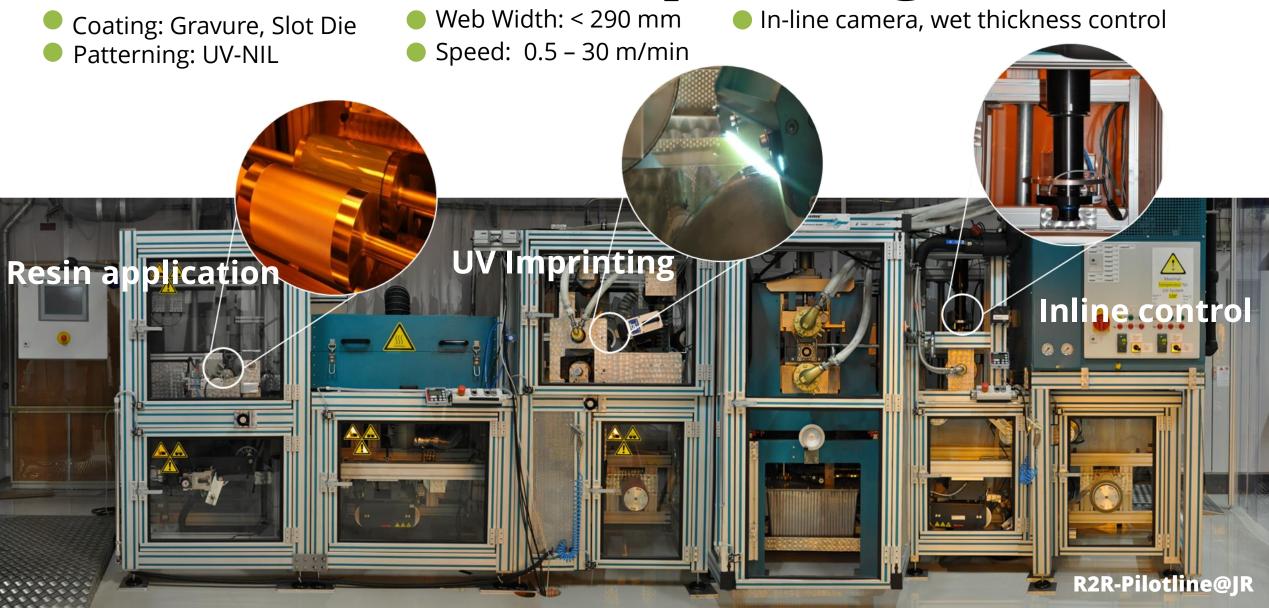
- 2.5D, several layers
- Up to 150 µm depth



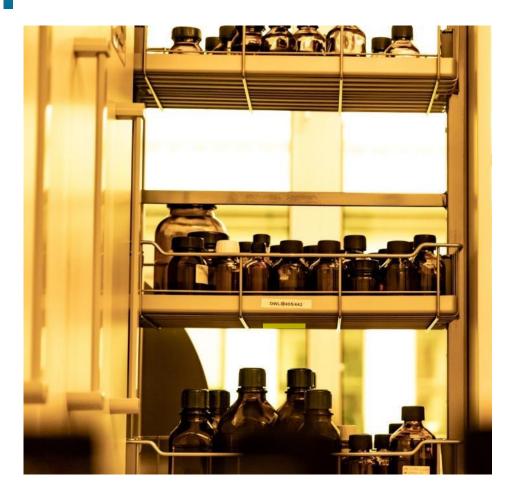








Resins for R2R UV Imprinting



Resin properties relevant for μ -fluidics:

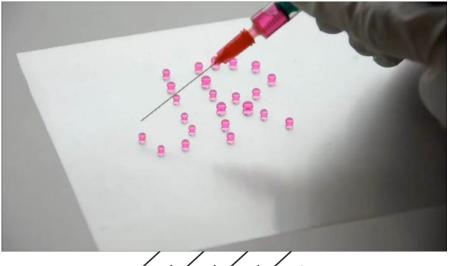
- Fast curing, low viscosity
- Low water contact angle
- No significant swelling
- Low cytotoxicity
- Low auto-fluorescence
- Providing "anchor-groups" for bio-functionalization
- Tunable elasticity
- Possibly biobased materials

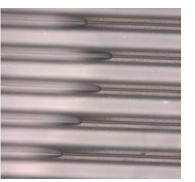
Parameters can be adjusted to customers' needs

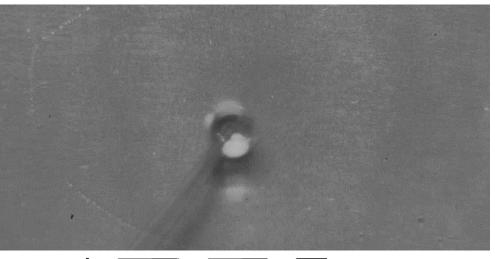


Customizable properties by material choice



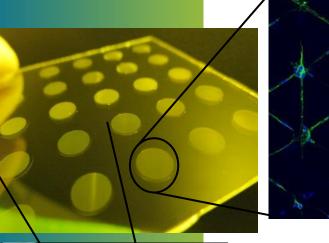


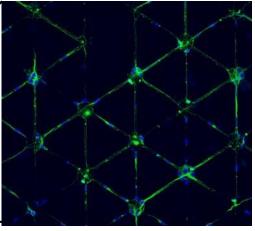






Example 1: Neuronal cell assay

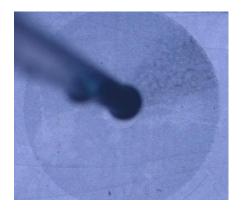




µ-fluidic pattern for guidance of neuronal cells

- Drug and assay testing
- Imprint pattern: $\mu\mbox{-fluidic}$ mesh with 17 $\mu\mbox{m}$ height, 5-10 $\mu\mbox{m}$ width
- Fabrication speed: 1m/min
- Imprint resist: mr-UVCur26SF





M.Lohse et. al, Nanomaterials 2021, 11, 902. https://doi.org/10.3390/nano11040902

- Excellent cell compatibility towards neurons and other cells
- Low background signals due to optimized autofluorescence
 - Improved signal deviation in preliminary assay testing due to well separated neurons



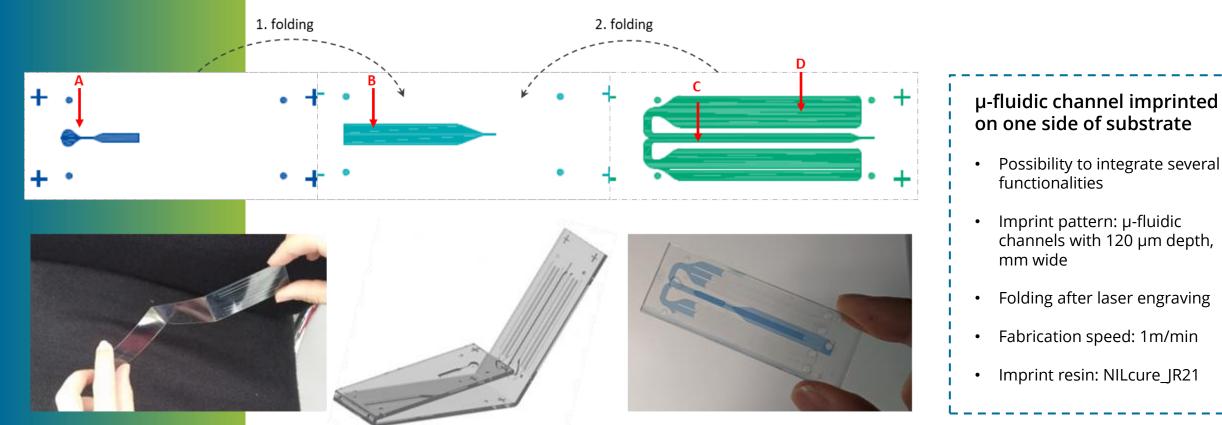




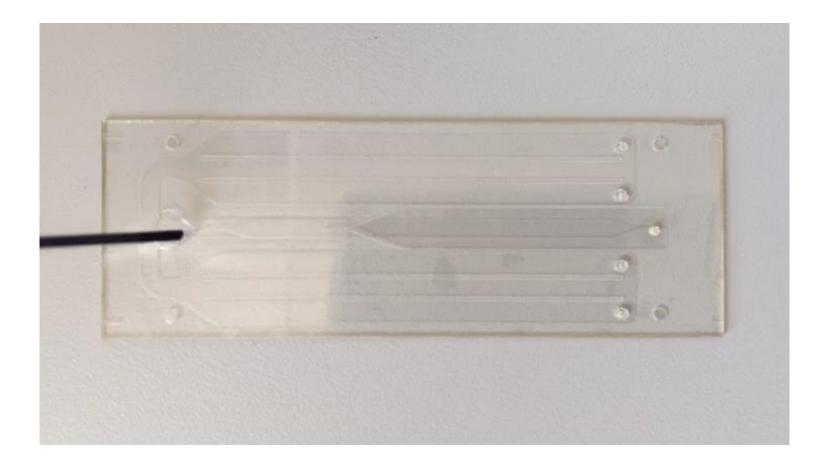




Example 2: Origami Chips for 3D Microfluidics



Example 2: Origami Chips for 3D Microfluidics





Example 3: Roll-to-roll based production of Lab-on-a-Foil



Fabrication of LoC Chip via R2R UV-NIL

- Imprint pattern: µ-fluidic chip with 150 µm height
- Fabrication speed: 4m/min
- Imprint resist: mr-BioNIL100SF_XPA
- Commercial readout system based on chemoluminescence
- Transfer of fluidic structures from injection molding to R2R-produced µF-channels
- Excellent filling of bonded chip due to intrinsic hydrophilicity
- Adjusted surface chemistry allows direct spotting of antigens
- Fast R2R fabrication with up to 1000 chips/hour

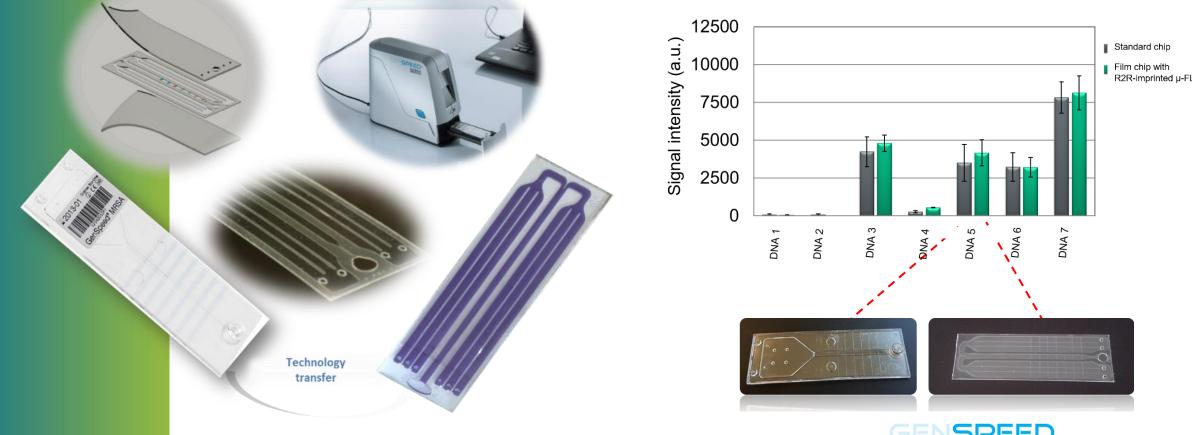


P. Tören et al., MRS Advances 2021, <u>https://doi.org/10.1557/s43580-021-00064-7;</u> P. Tören et a<mark>l</mark>., Lab on Chip 20, 4106 (2020)

Microfluidics

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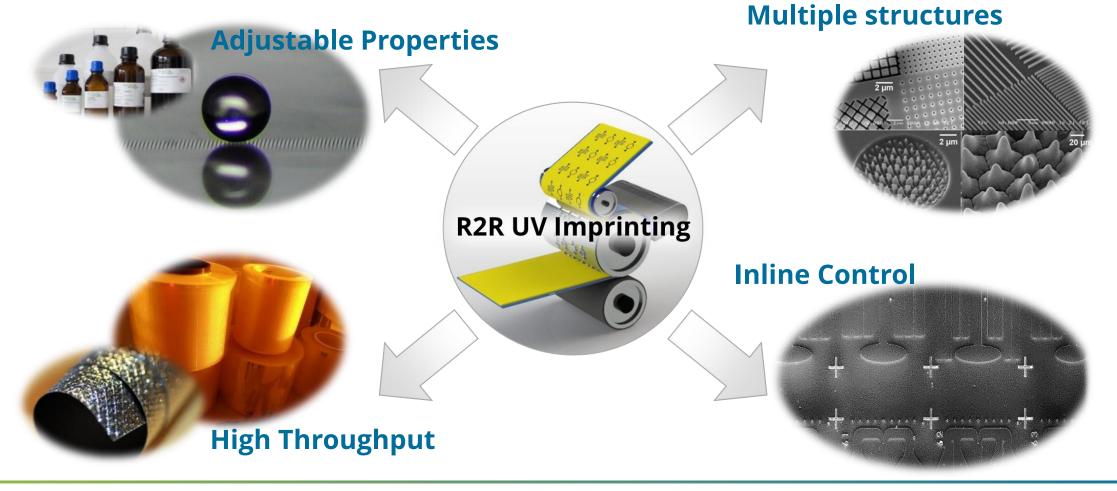
Example 3: Roll-to-roll based production of Lab-on-a-Foil



Microfluidics InnovationHub Transfer of fluidic structures from injection molding to R2R-produced µF-channels



Conclusion of Roll-to-Roll UV Imprinting







Roll-to-roll Extrusion Coating

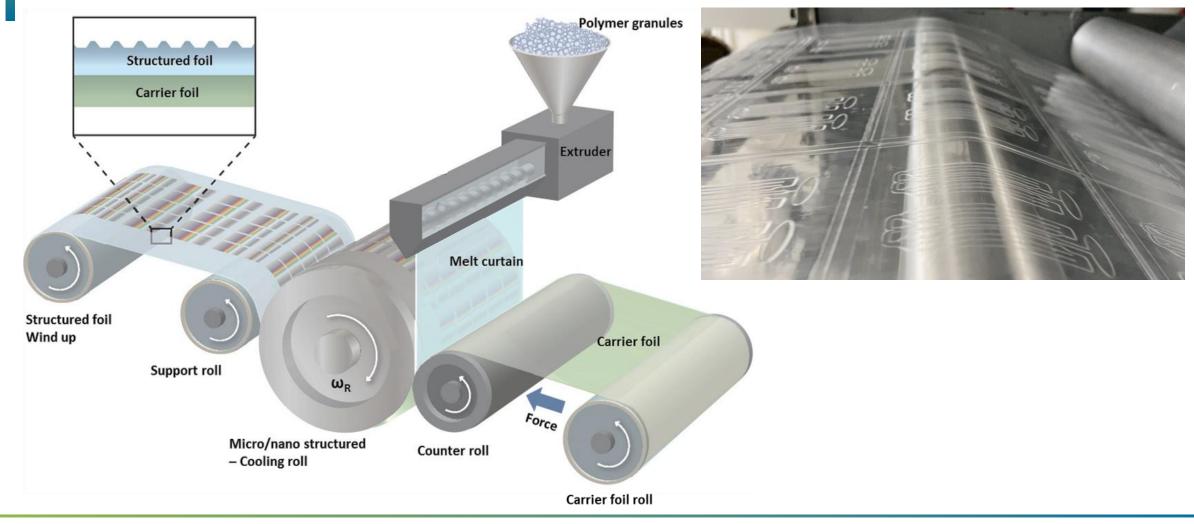






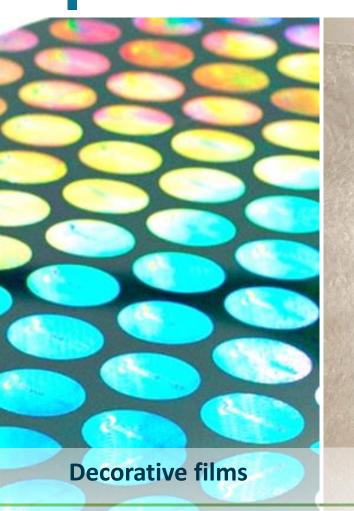


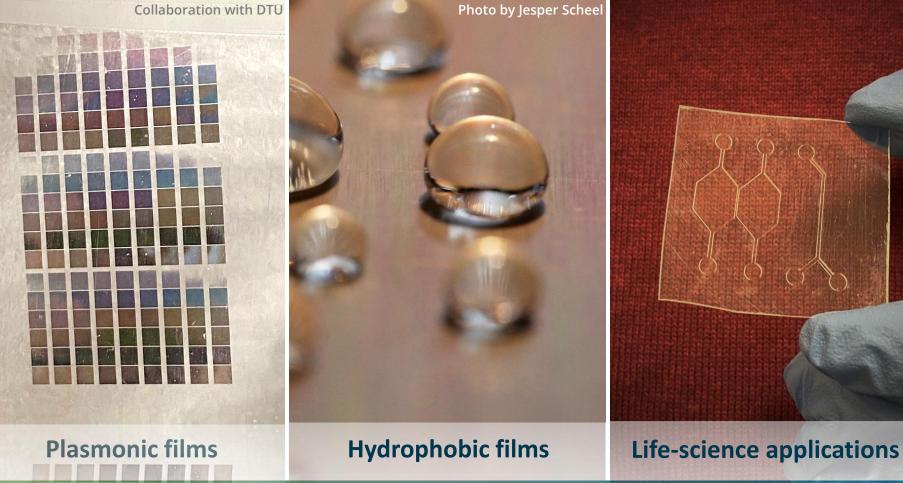
Principle of R2R-Extrusion Coating





Surface patterning for surface functionalization







Microfluidics InnovationHub

Why R2R-EC for life-science?

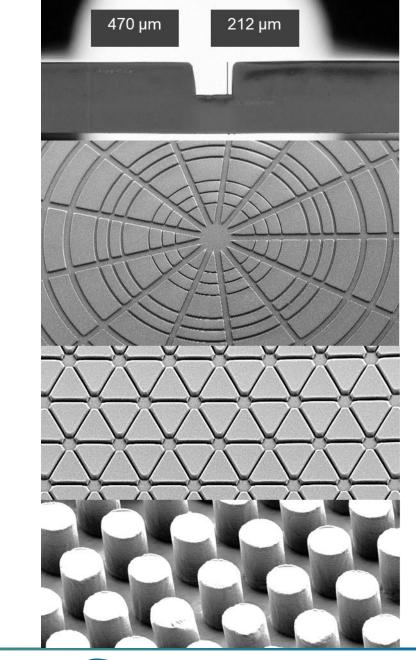
- Thermoplastic polymer (TP):
 - Polypropylene (PP)
 - Polystyrene (PS)
 - Cyclic Olefin Copolymer (COC)
 - Other materials on request
- Chemical surface functionalizations established for TP are applicable
- Traditional bonding methods useable
- High production speeds of several m/min fulfill increasing demand of microfluidic market





Advantages of R2R-EC

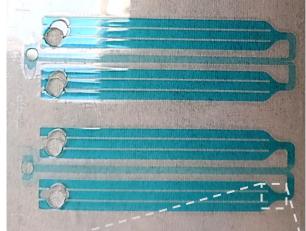
- Film production with thicknesses up to 500µm (structure imprint depth of up to 300µm)
 - High rigidity of produced films
 - Less material due to exclusion of bulk
 - Short distance between samples and detector
- Patterning of large surface areas possible allowing upscaling of microfluidic design
- High directional freedom of design (for AR \leq 1)
- No draft angle necessary

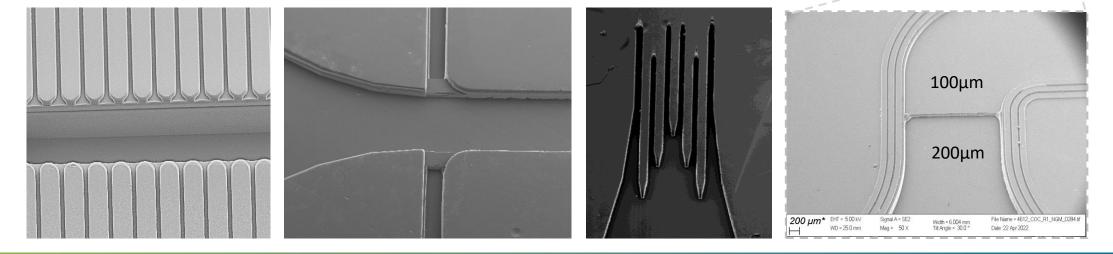




Imprint technology for complex microfluidic designs

- Implementation of energy directors for bonding
- Multiple-level fluidic networks
- High through-put filters
- Large area mixers for life-science application

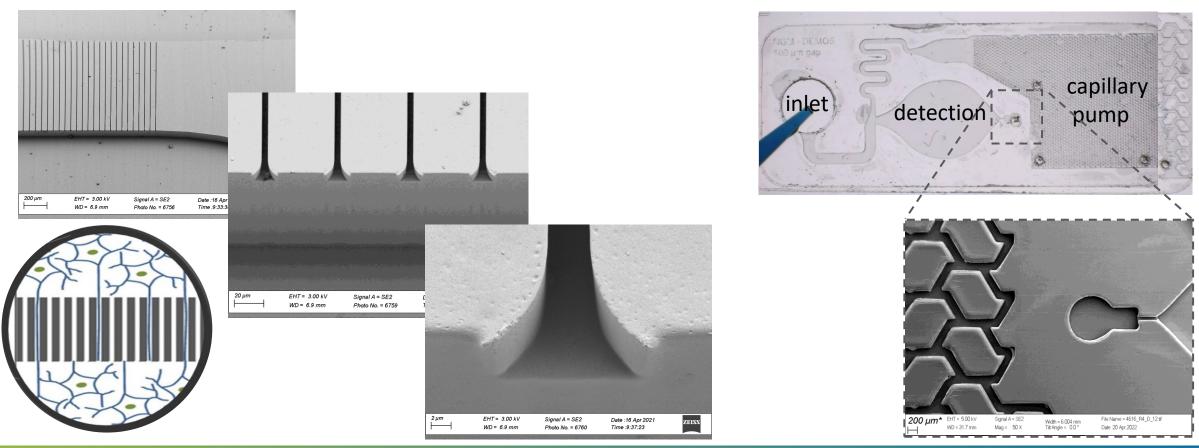






Examples of high aspect replication

Cell culture device

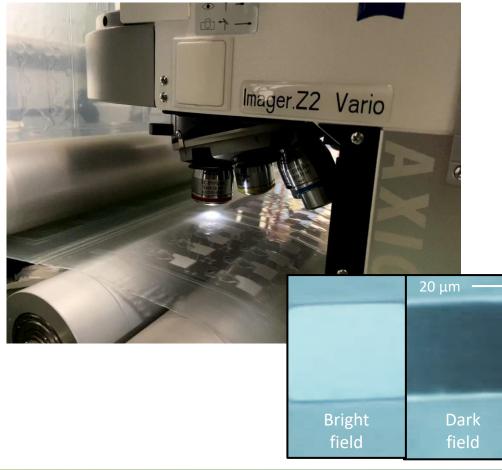




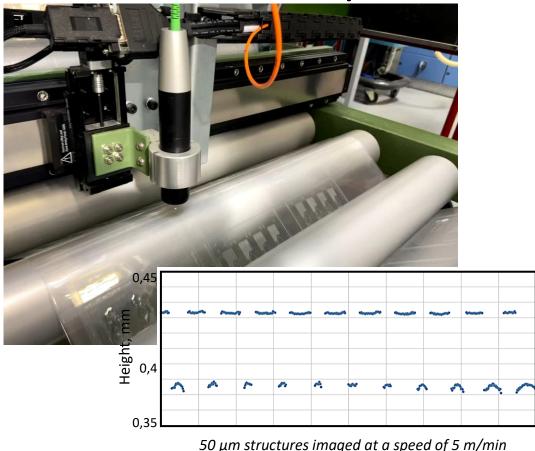
Sensor for Bioreactor Control

In-line Quality Control

Optical Microscope



Confocal Microscope





Summary R2R-Extrusion Coating

- Large-scale replication technique using thermoplastic polymer
- Surface functionalization and bonding techniques developed for thermoplastic polymers are compatible with R2R-EC
- Unique imprint regime allows replication of complex fluidic systems with substrate thicknesses up to 500µm
- Inline control allows quality control and parameter adjustment during production





Design Mastering

Patterning functionalisation

Surface Electrodes ctionalisation Sensors Backend Services

Read Out Device System Integration



QM



Back-end Processing





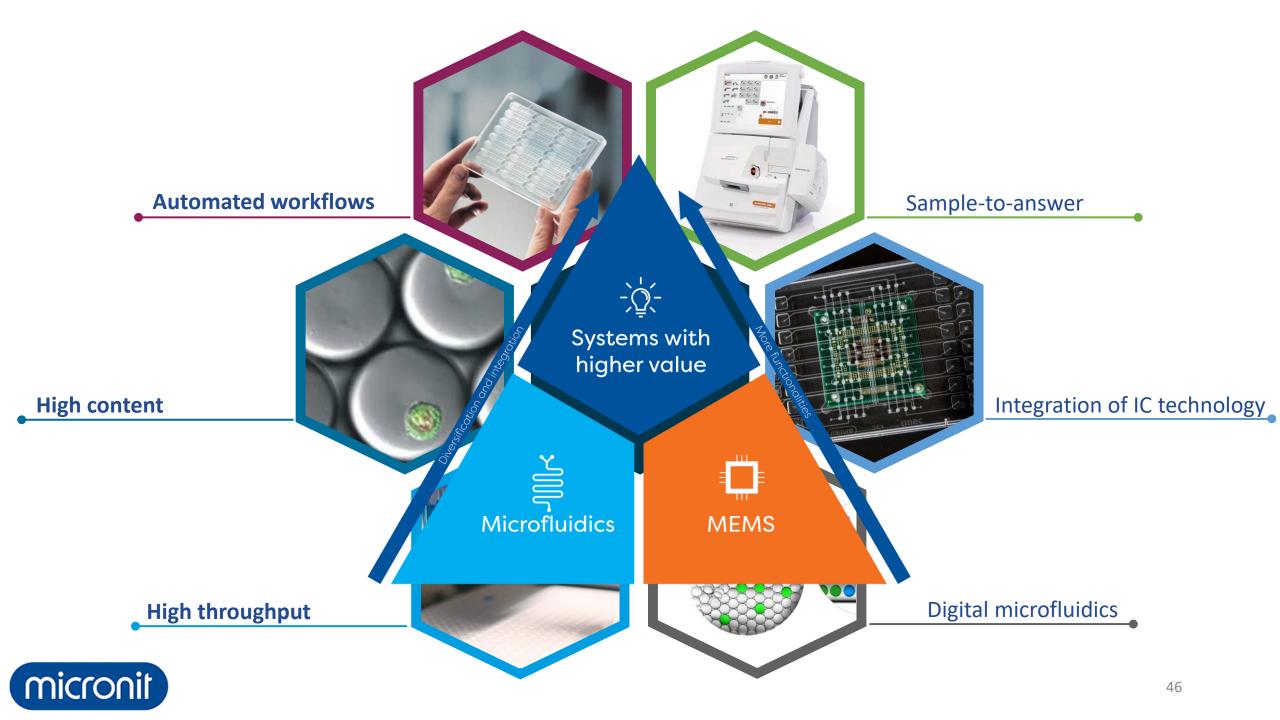
Micronit BV

- Founded in 1999
- Located in Enschede, the Netherlands and Dortmund, Germany
- 1000+ customers in 50+ countries
- We serve leading companies in the top 25 of life science, diagnostics and biotechnology industries and world's top 10 technical universities
- 120+ highly educated, multi-disciplinary employees, 15+ nationalities
- ISO 9001 and ISO 13485 certified

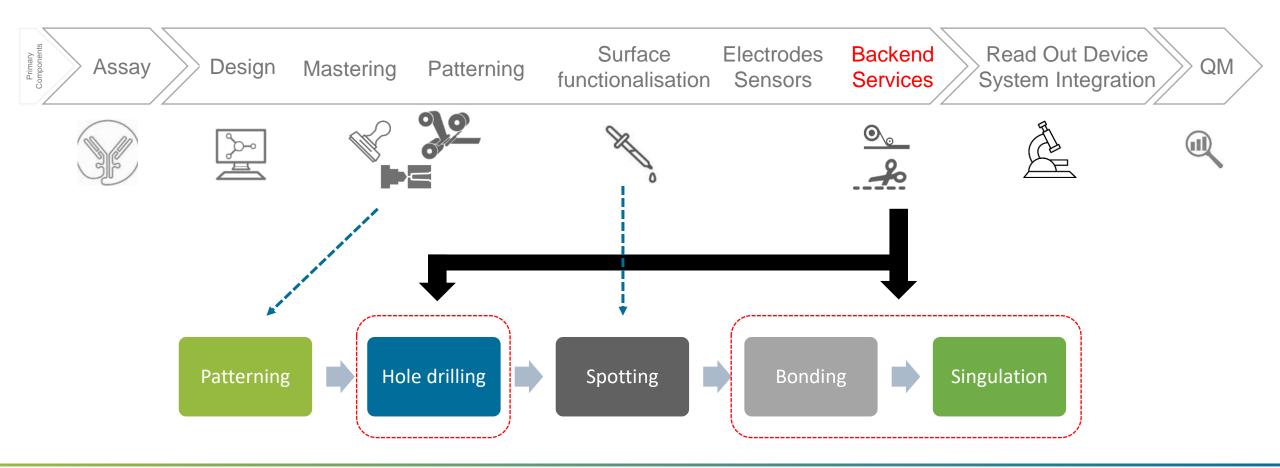








Process overview

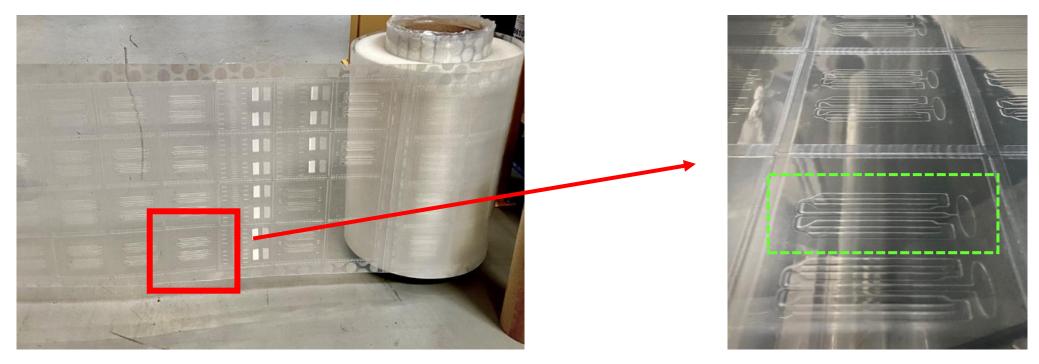




The foils – Example EC COC

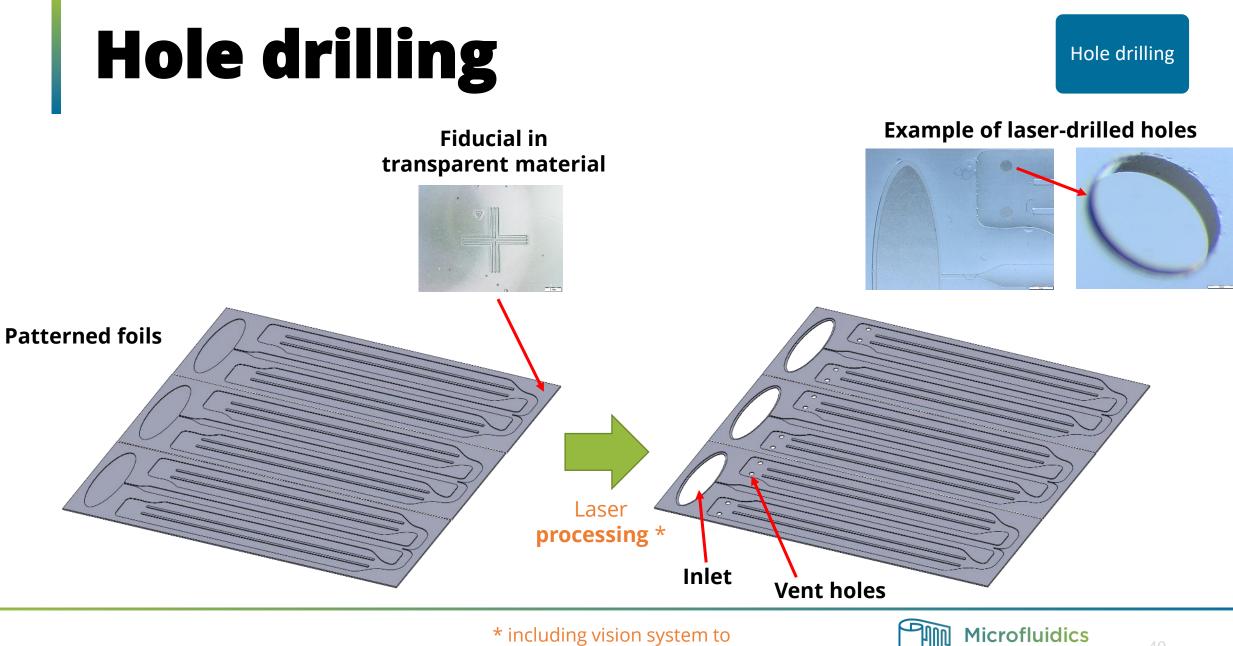
Patterning

Un-winded roll



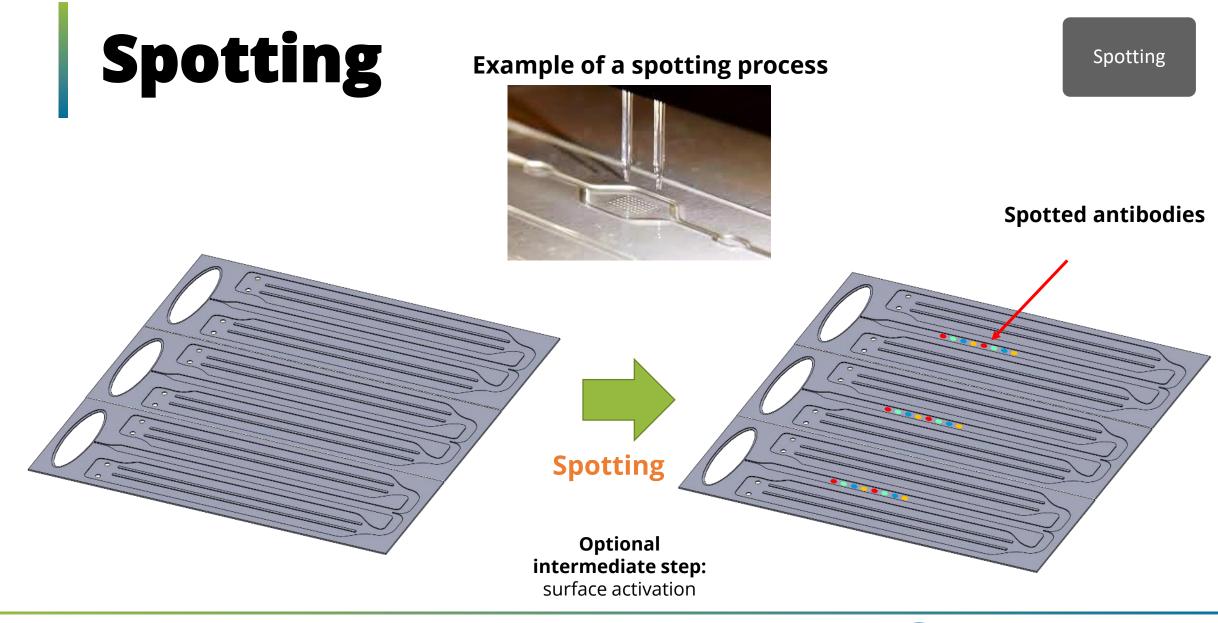
"Chip"





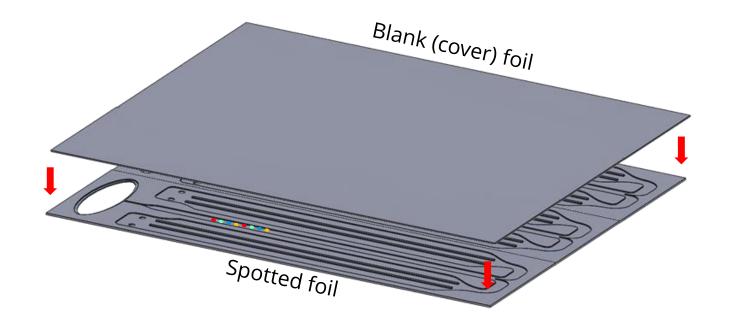
align on imprinted fiducials

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Bonding



Available bonding techniques

- 1. Extrusion coating
 - Solvent-assisted bonding
 - Ultrasonic welding
 - Thermal lamination
 - Laser welding *
- 2. UV-NIL
 - Partially cured resin

* Method under investigation



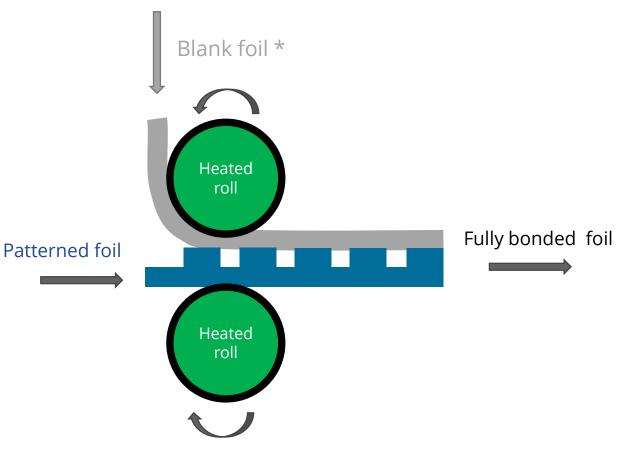
Bonding - EC

R2R thermal lamination

- High throughput and simple process
- Temperatures above the Tg of the material → integrated biology degradation

R2R solvent-assisted bonding

- High throughput yet complex process (dangerous solvent vapors)
- Temperatures below the Tg of the material → integrated biology degradation preservation
- Solvent residues might alter cellbased assays and/or biology



* Previously exposed to solvent for the solvent method

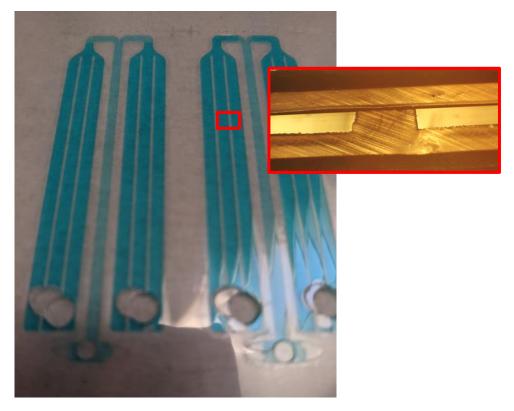


Bonding



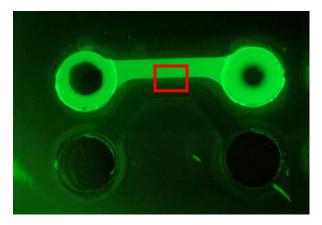
Examples R2R thermal lamination

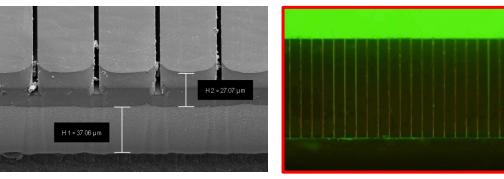
Antibody SARS-CoV2 test



Examples R2R solvent-assisted bonding

Neural cell culture device



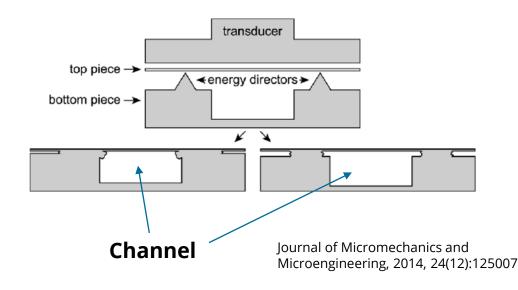




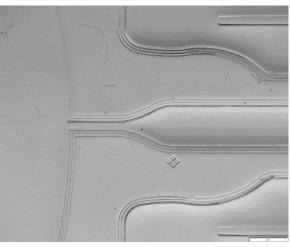
Bonding - EC

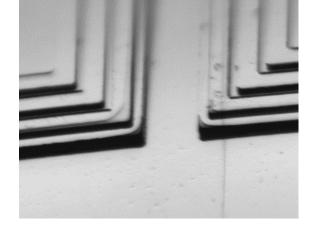
Ultrasonic welding

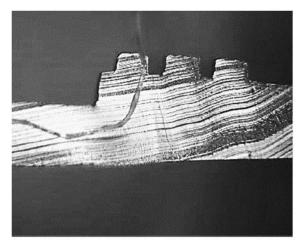
- Mid throughput process (can be implemented R2R in a stop & go fashion)
- Low-temperature process → preservation of biology
- No solvents/promotors involved



Energy directors patterned directly on foils





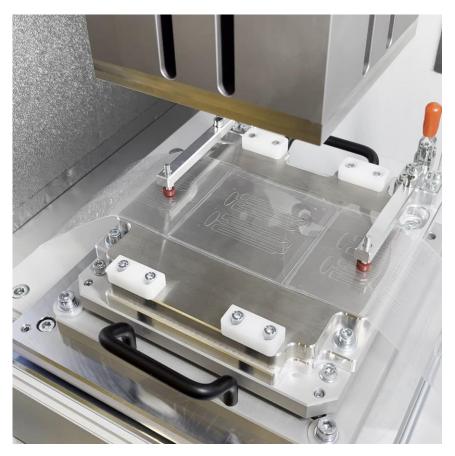




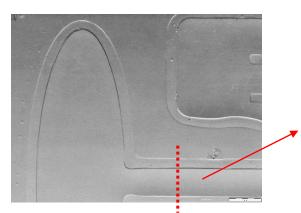
Bonding

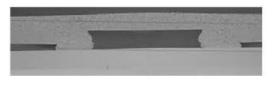
Bonding - EC

Results





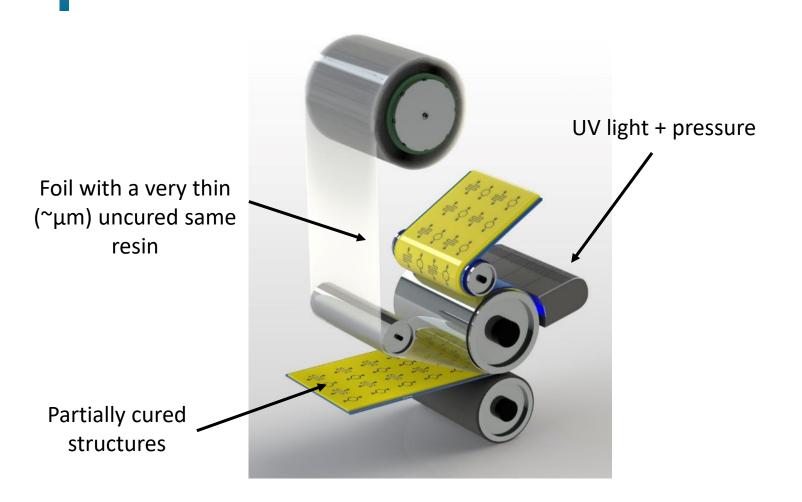


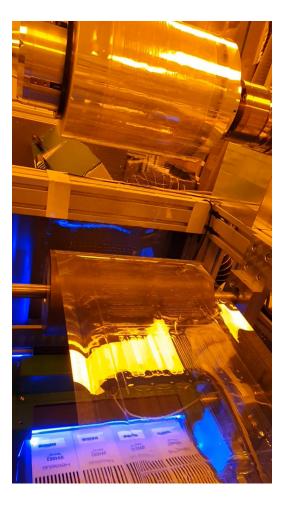




Bonding – UV Imprinting

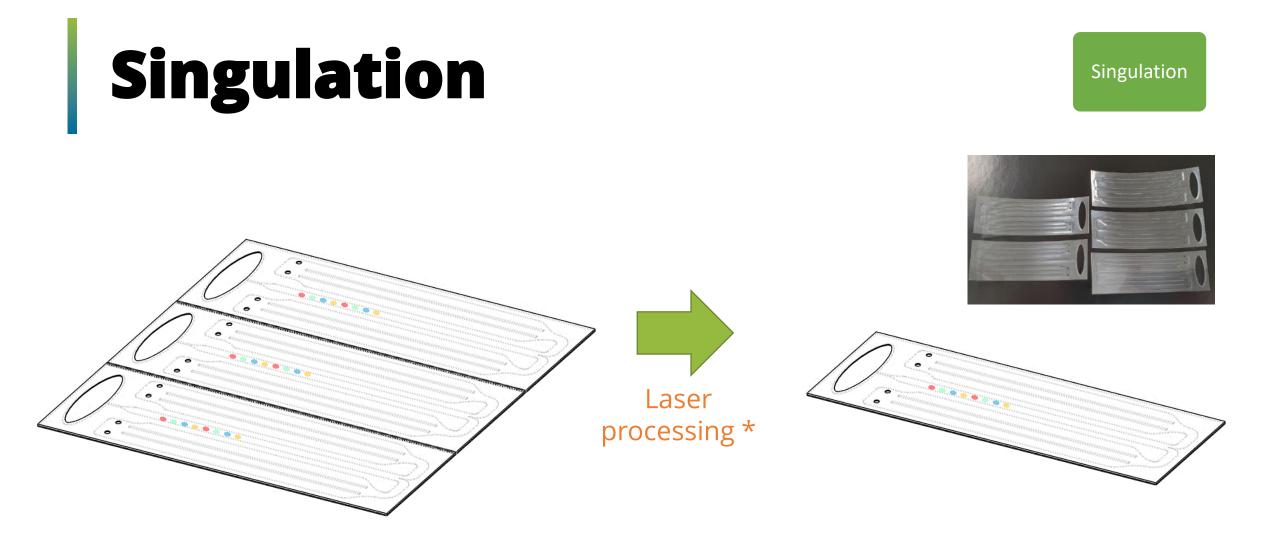
Bonding





DE102020114621A1 WO2021244796A1



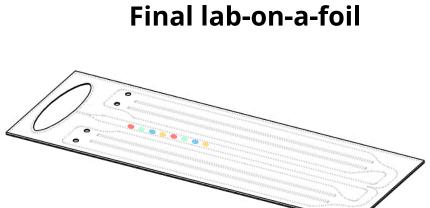


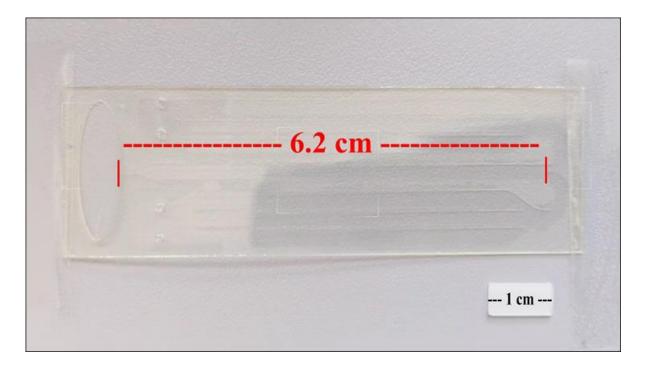
* including vision system to align on imprinted fiducials



Singulation

Singulation





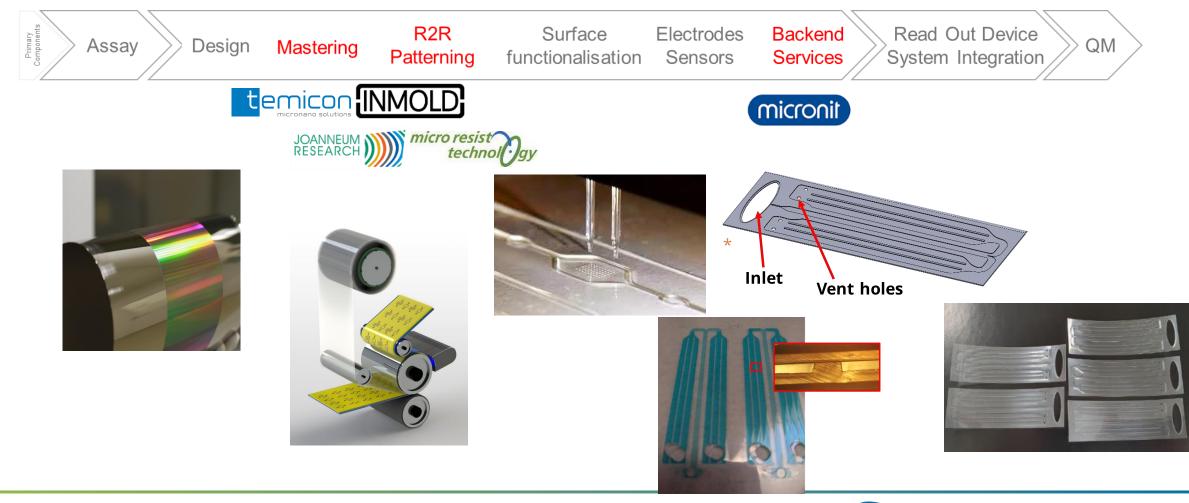




SUMMARY



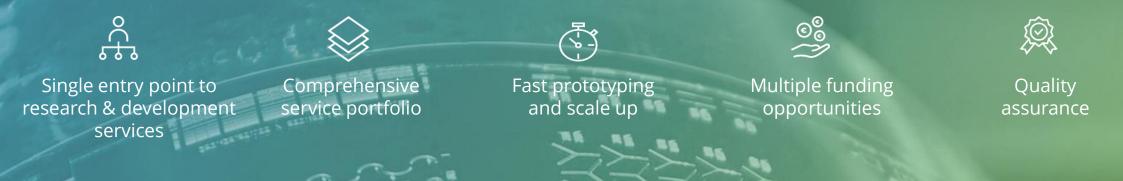
Topics Presented







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Questions & Answering

